

## Features

- Dual N-Channel MOSFET
- Low On-Resistance
- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Ultra-Small Surface Mount Package
- **Lead Free By Design/RoHS Compliant (Note 1)**
- **ESD Protected Up To 2KV**
- **"Green" Device (Note 2)**
- **Qualified to AEC-Q101 Standards for High Reliability**

## Mechanical Data

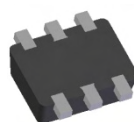
- Case: SOT-563
- Case Material: Molded Plastic, "Green" Molding Compound.  
UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram Below
- Terminals: Finish – Matte Tin annealed over Copper leadframe.  
Solderable per MIL-STD-202, Method 208
- Marking Information: See Page 4
- Ordering Information: See Page 4
- Weight: 0.006 grams (approximate)



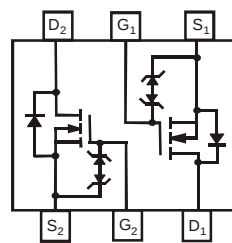
ESD PROTECTED TO 2kV



TOP VIEW



BOTTOM VIEW



TOP VIEW

## Maximum Ratings @T<sub>A</sub> = 25°C unless otherwise specified

| Characteristic                    |              |                       | Symbol           | Value | Unit |
|-----------------------------------|--------------|-----------------------|------------------|-------|------|
| Drain-Source Voltage              |              |                       | V <sub>DSS</sub> | 20    | V    |
| Gate-Source Voltage               |              |                       | V <sub>GSS</sub> | ±6    | V    |
| Continuous Drain Current (Note 3) | Steady State | T <sub>A</sub> = 25°C | I <sub>D</sub>   | 1.38  | A    |
|                                   |              | T <sub>A</sub> = 85°C |                  | 0.89  |      |
| Pulsed Drain Current (Note 4)     |              |                       | I <sub>DM</sub>  | 3     | A    |

## Thermal Characteristics

| Characteristic                                                          | Symbol                            | Max         | Unit |
|-------------------------------------------------------------------------|-----------------------------------|-------------|------|
| Power Dissipation (Note 3)                                              | P <sub>D</sub>                    | 530         | mW   |
| Thermal Resistance, Junction to Ambient @T <sub>A</sub> = 25°C (Note 3) | R <sub>θJA</sub>                  | 235         | °C/W |
| Operating and Storage Temperature Range                                 | T <sub>J</sub> , T <sub>STG</sub> | -55 to +150 | °C   |

- Notes:
1. No purposefully added lead.
  2. Diodes Inc.'s "Green" policy can be found on our website at [http://www.diodes.com/products/lead\\_free/index.php](http://www.diodes.com/products/lead_free/index.php).
  3. Device mounted on FR-4 PCB, with minimum recommended pad layout.
  4. Repetitive rating, pulse width limited by junction temperature.

# Electrical Characteristics @T<sub>A</sub> = 25°C unless otherwise specified

| Characteristic                                        | Symbol              | Min | Typ   | Max  | Unit | Test Condition                                                                                                          |
|-------------------------------------------------------|---------------------|-----|-------|------|------|-------------------------------------------------------------------------------------------------------------------------|
| <b>OFF CHARACTERISTICS (Note 5)</b>                   |                     |     |       |      |      |                                                                                                                         |
| Drain-Source Breakdown Voltage                        | BV <sub>DSS</sub>   | 20  | -     | -    | V    | V <sub>GS</sub> = 0V, I <sub>D</sub> = 250μA                                                                            |
| Zero Gate Voltage Drain Current T <sub>J</sub> = 25°C | I <sub>DSS</sub>    | -   | -     | 100  | nA   | V <sub>DS</sub> = 20V, V <sub>GS</sub> = 0V                                                                             |
| Gate-Source Leakage                                   | I <sub>GSS</sub>    | -   | -     | ±1.0 | μA   | V <sub>GS</sub> = ±4.5V, V <sub>DS</sub> = 0V                                                                           |
| <b>ON CHARACTERISTICS (Note 5)</b>                    |                     |     |       |      |      |                                                                                                                         |
| Gate Threshold Voltage                                | V <sub>GS(th)</sub> | 0.5 | -     | 1.0  | V    | V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250μA                                                              |
| Static Drain-Source On-Resistance                     | R <sub>DS(on)</sub> | -   | 0.3   | 0.45 | Ω    | V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 600mA                                                                          |
|                                                       |                     |     | 0.4   | 0.6  |      | V <sub>GS</sub> = 2.5V, I <sub>D</sub> = 500mA                                                                          |
|                                                       |                     |     | 0.5   | 0.75 |      | V <sub>GS</sub> = 1.8V, I <sub>D</sub> = 350mA                                                                          |
|                                                       |                     |     | -     | 9    |      | V <sub>GS</sub> = 1.7V, I <sub>D</sub> = 140mA                                                                          |
|                                                       |                     |     | -     | 10   |      | V <sub>GS</sub> = 1.5V, I <sub>D</sub> = 100mA                                                                          |
| Forward Transfer Admittance                           | Y <sub>fs</sub>     | -   | 1.4   | -    | S    | V <sub>DS</sub> = 10V, I <sub>D</sub> = 400mA                                                                           |
| Diode Forward Voltage                                 | V <sub>SD</sub>     |     | 0.7   | 1.2  | V    | V <sub>GS</sub> = 0V, I <sub>S</sub> = 150mA                                                                            |
| <b>DYNAMIC CHARACTERISTICS (Note 6)</b>               |                     |     |       |      |      |                                                                                                                         |
| Input Capacitance                                     | C <sub>iss</sub>    | -   | 60.67 | -    | pF   | V <sub>DS</sub> = 16V, V <sub>GS</sub> = 0V,<br>f = 1.0MHz                                                              |
| Output Capacitance                                    | C <sub>oss</sub>    | -   | 9.68  | -    | pF   |                                                                                                                         |
| Reverse Transfer Capacitance                          | C <sub>rss</sub>    | -   | 5.37  | -    | pF   |                                                                                                                         |
| Total Gate Charge                                     | Q <sub>g</sub>      | -   | 736.6 | -    | pC   | V <sub>GS</sub> = 4.5V, V <sub>DS</sub> = 10V,<br>I <sub>D</sub> = 250mA                                                |
| Gate-Source Charge                                    | Q <sub>gs</sub>     | -   | 93.6  | -    | pC   |                                                                                                                         |
| Gate-Drain Charge                                     | Q <sub>gd</sub>     | -   | 116.6 | -    | pC   |                                                                                                                         |
| Turn-On Delay Time                                    | t <sub>D(on)</sub>  | -   | 5.1   | -    | ns   | V <sub>DD</sub> = 10V, V <sub>GS</sub> = 4.5V,<br>R <sub>L</sub> = 47Ω, R <sub>G</sub> = 10Ω,<br>I <sub>D</sub> = 200mA |
| Turn-On Rise Time                                     | t <sub>r</sub>      | -   | 7.4   | -    | ns   |                                                                                                                         |
| Turn-Off Delay Time                                   | t <sub>D(off)</sub> | -   | 26.7  | -    | ns   |                                                                                                                         |
| Turn-Off Fall Time                                    | t <sub>f</sub>      | -   | 12.3  | -    | ns   |                                                                                                                         |

Notes: 5. Short duration pulse test used to minimize self-heating effect.  
6. Guaranteed by design. Not subject to production testing.

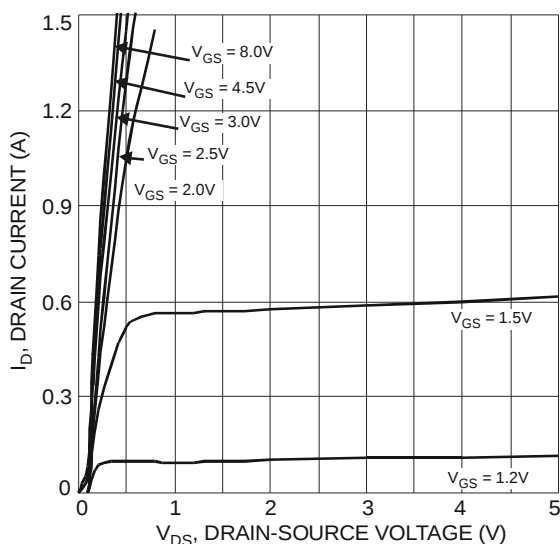


Fig. 1 Typical Output Characteristics

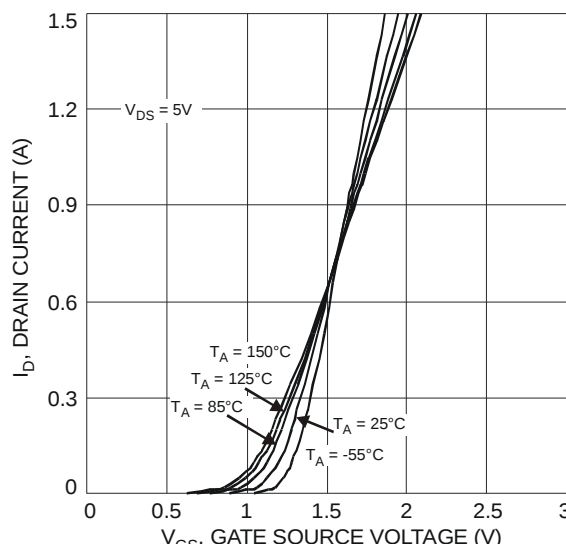
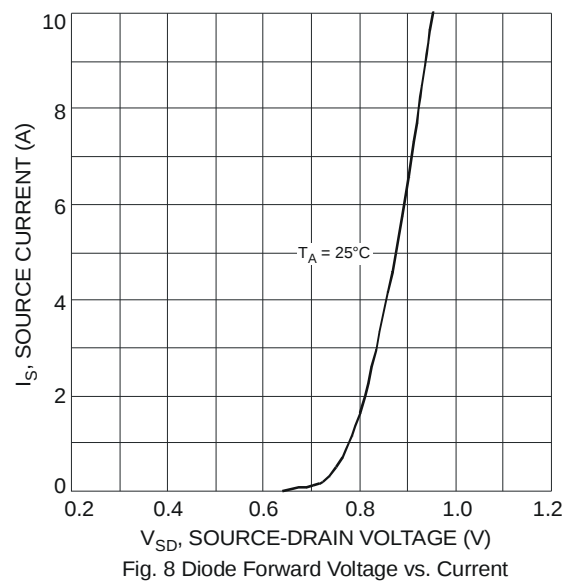
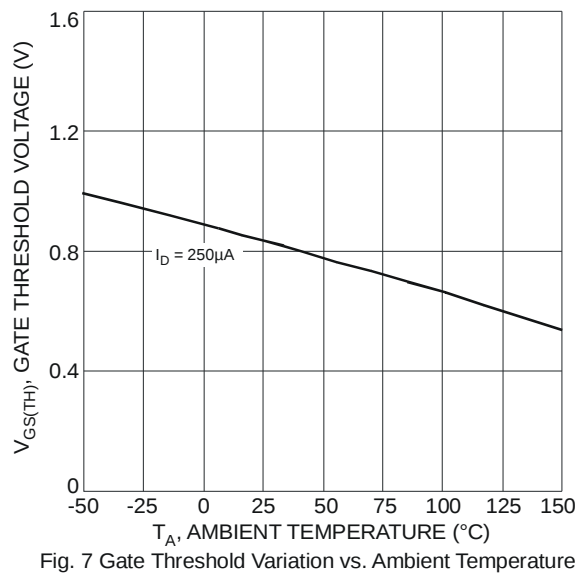
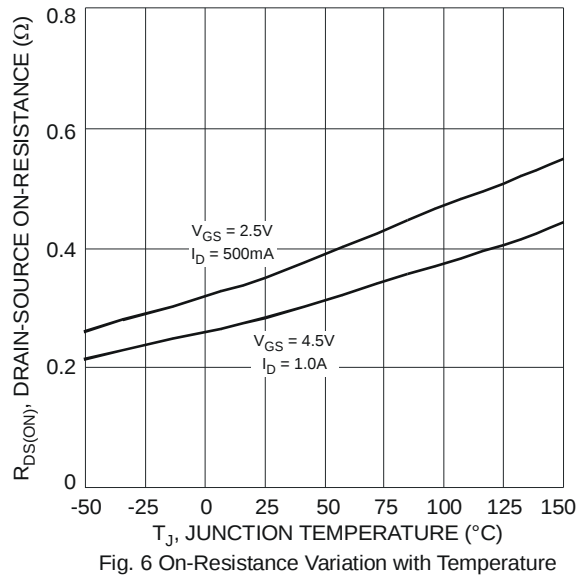
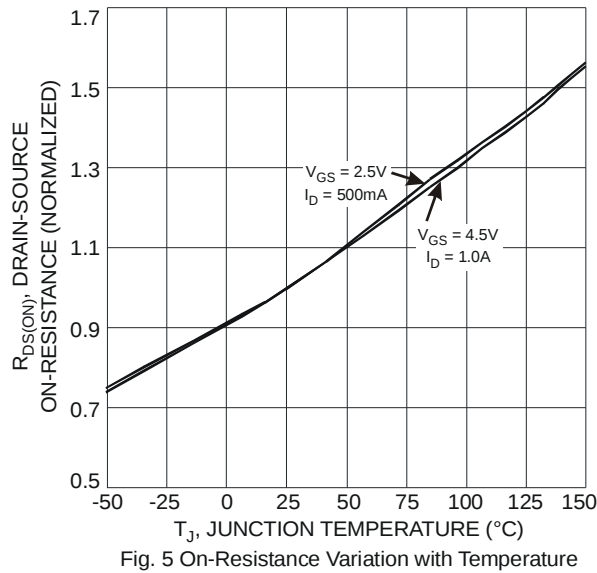
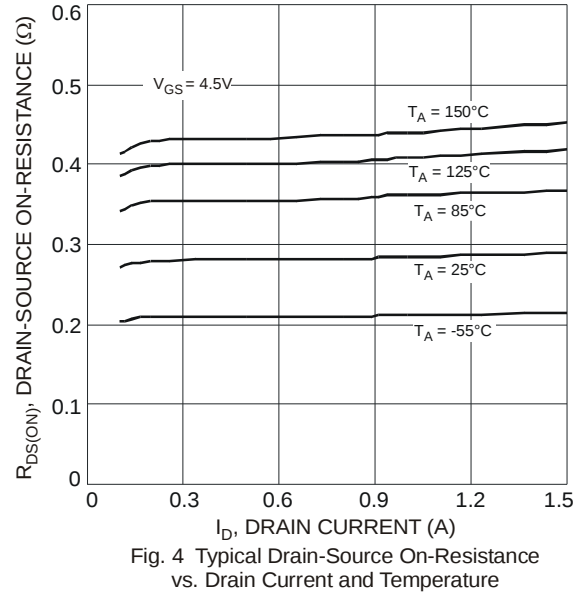
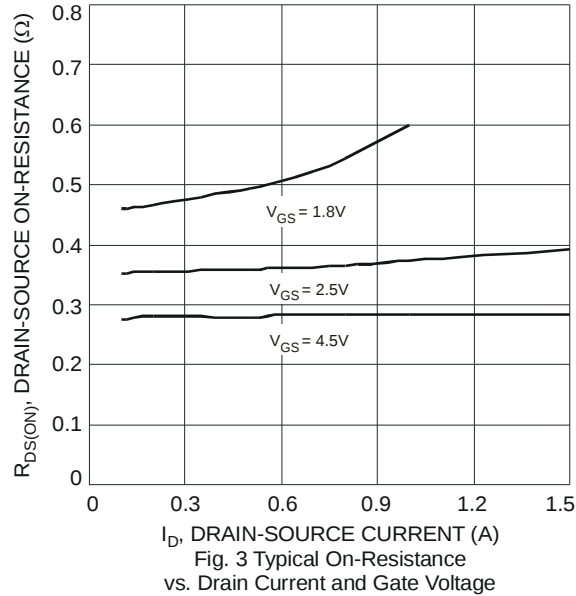


Fig. 2 Typical Transfer Characteristics



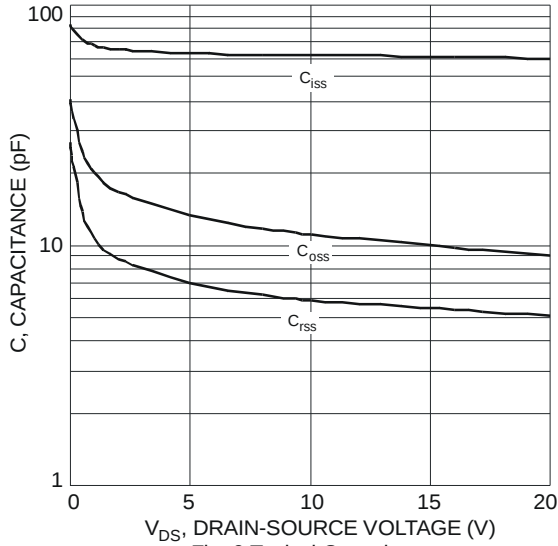


Fig. 9 Typical Capacitance

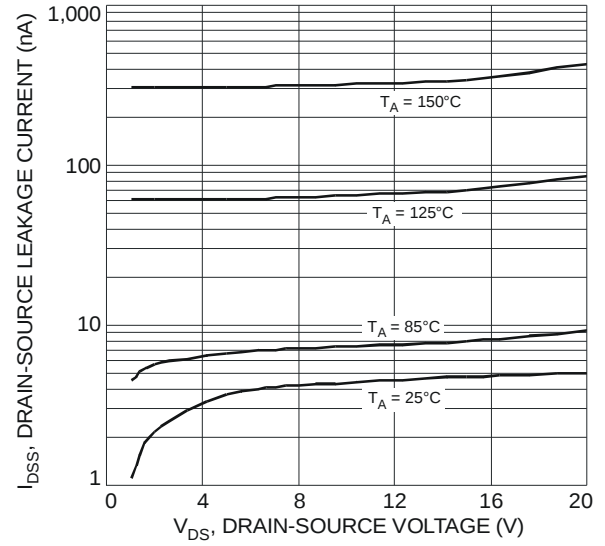


Fig. 10 Typical Drain-Source Leakage Current vs. Drain-Source Voltage

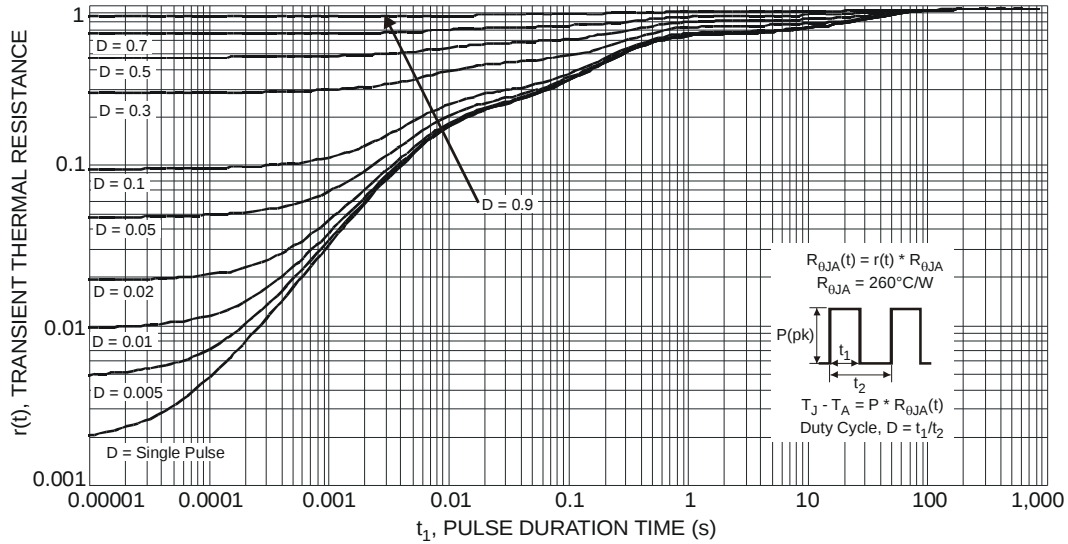


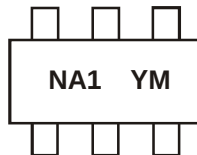
Fig. 11 Transient Thermal Response

## Ordering Information (Note 7)

| Part Number | Case    | Packaging          |
|-------------|---------|--------------------|
| DMG1024UV-7 | SOT-563 | 3000 / Tape & Reel |

Notes: 7. For packaging details, go to our website at <http://www.diodes.com/datasheets/ap02007.pdf>.

## Marking Information



NA1 = Product Type Marking Code  
YM = Date Code Marking  
Y = Year (ex: W = 2009)  
M = Month (ex: 9 = September)

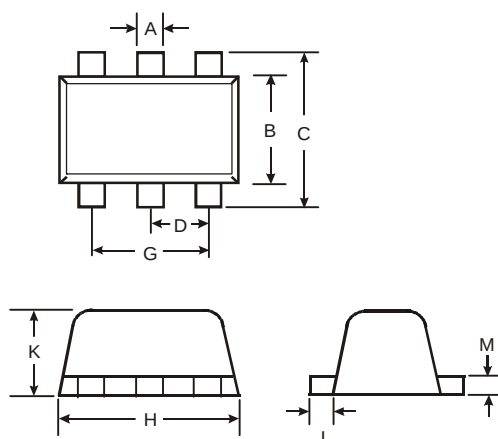
### Date Code Key

| Year | 2009 | 2010 | 2011 | 2012 | 2013 | 2014 | 2015 |
|------|------|------|------|------|------|------|------|
| Code | W    | X    | Y    | Z    | A    | B    | C    |

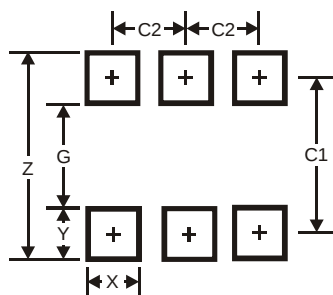
| Month | Jan | Feb | Mar | Apr | May | Jun | Jul | Aug | Sep | Oct | Nov | Dec |
|-------|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|
| Code  | 1   | 2   | 3   | 4   | 5   | 6   | 7   | 8   | 9   | O   | N   | D   |

## Package Outline Dimensions



| SOT-563              |      |      |      |
|----------------------|------|------|------|
| Dim                  | Min  | Max  | Typ  |
| A                    | 0.15 | 0.30 | 0.20 |
| B                    | 1.10 | 1.25 | 1.20 |
| C                    | 1.55 | 1.70 | 1.60 |
| D                    | -    | -    | 0.50 |
| G                    | 0.90 | 1.10 | 1.00 |
| H                    | 1.50 | 1.70 | 1.60 |
| K                    | 0.55 | 0.60 | 0.60 |
| L                    | 0.10 | 0.30 | 0.20 |
| M                    | 0.10 | 0.18 | 0.11 |
| All Dimensions in mm |      |      |      |

## Suggested Pad Layout



| Dimensions | Value (in mm) |
|------------|---------------|
| Z          | 2.2           |
| G          | 1.2           |
| X          | 0.375         |
| Y          | 0.5           |
| C1         | 1.7           |
| C2         | 0.5           |

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